## N-Channel 30-V (D-S) MOSFET

| PRODUCT SUMMARY |  |  |
| :---: | :---: | :---: |
| $\mathbf{V}_{\mathbf{D S}}(\mathbf{V})$ | $\mathbf{R}_{\mathrm{DS}(\text { on })}(\Omega)$ | $\mathbf{I}_{\mathbf{D}}(\mathbf{A})^{\mathbf{b}}$ |
| 30 | 0.0095 at $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}$ | $63^{\mathrm{b}}$ |
|  | 0.014 at $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}$ | $52^{\mathrm{b}}$ |

## FEATURES

- TrenchFET ${ }^{\circledR}$ Power MOSFET
- Optimized for High- or Low-Side
- $100 \% \mathrm{R}_{\mathrm{g}}$ Tested


## APPLICATIONS

- DC/DC Converters
- Synchronous Rectifiers

N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$, unless otherwise noted |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
| Parameter |  | Symbol | Limit | Unit |
| Drain-Source Voltage |  | $\mathrm{V}_{\mathrm{DS}}$ | 30 | V |
| Gate-Source Voltage |  | $V_{G S}$ | $\pm 20$ |  |
| Continuous Drain Current ${ }^{\text {a }}$ | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | ID | $63^{\text {b }}$ | A |
| Continuous Drain Current | $\mathrm{T}_{\mathrm{C}}=100^{\circ} \mathrm{C}$ |  | $44.5{ }^{\text {b }}$ |  |
| Pulsed Drain Current |  | $I_{\text {DM }}$ | 50 |  |
| Continuous Source Current (Diode Conduction) ${ }^{\text {a }}$ |  | $\mathrm{I}_{\mathrm{S}}$ | 5 |  |
| Avalanche Current | $\mathrm{L}=0.1 \mathrm{mH}$ | $\mathrm{I}_{\text {AS }}$ | 35 |  |
| Single Pulse Avalanche Energy |  | $\mathrm{E}_{\text {AS }}$ | 61 | mJ |
| Maximum Power Dissipation | $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ | $\mathrm{P}_{\mathrm{D}}$ | 65.2 | W |
|  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | $7.5^{\text {a }}$ |  |
| Operating Junction and Storage Temperature Range |  | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\mathrm{stg}}$ | - 55 to 175 | ${ }^{\circ} \mathrm{C}$ |

## THERMAL RESISTANCE RATINGS

| Parameter |  | Symbol | Typical | Maximum | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Maximum Junction-to-Ambient ${ }^{\text {a }}$ | $\mathrm{t} \leq 10 \mathrm{~s}$ | $\mathrm{R}_{\text {thJA }}$ | 16 | 20 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
|  | Steady State |  | 40 | 50 |  |
| Maximum Junction-to-Case |  | $\mathrm{R}_{\text {thJC }}$ | 1.8 | 2.3 |  |

## Notes:

a. Surface Mounted on FR4 board, $\mathrm{t} \leq 10 \mathrm{~s}$.
b. Based on maximum allowable Junction Temperature, package limitation current is 50 A .

* Pb containing terminations are not RoHS compliant, exemptions may apply.

| SPECIFICATIONS $\mathrm{T}_{J}=25^{\circ} \mathrm{C}$, unless otherwise noted |  |  |  |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Parameter | Symbol | Test Conditions | Min. | Typ. ${ }^{\text {a }}$ | Max. | Unit |
| Static |  |  |  |  |  |  |
| Drain-Source Breakdown Voltage | $\mathrm{V}_{\text {(BR)DSS }}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 30 |  |  | V |
| Gate Threshold Voltage | $\mathrm{V}_{\mathrm{GS}(\mathrm{th})}$ | $\mathrm{V}_{\mathrm{DS}}=\mathrm{V}_{\mathrm{GS}}, \mathrm{I}_{\mathrm{D}}=250 \mu \mathrm{~A}$ | 1.0 |  | 3.0 |  |
| Gate-Body Leakage | $\mathrm{I}_{\text {GSS }}$ | $\mathrm{V}_{\mathrm{DS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}$ |  |  | $\pm 100$ | nA |
| Zero Gate Voltage Drain Current | Idss | $\mathrm{V}_{\mathrm{DS}}=30 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  |  | 1 | $\mu \mathrm{A}$ |
|  |  | $\mathrm{V}_{\mathrm{DS}}=30 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  |  | 50 |  |
| On-State Drain Current ${ }^{\text {b }}$ | $\mathrm{I}_{\mathrm{D} \text { (on) }}$ | $\mathrm{V}_{\mathrm{DS}}=5 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=10 \mathrm{~V}$ | 50 |  |  | A |
| Drain-Source On-State Resistance ${ }^{\text {b }}$ | $\mathrm{R}_{\mathrm{DS} \text { (on) }}$ | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}$ |  | 0.0076 | 0.0095 | $\Omega$ |
|  |  | $\mathrm{V}_{\mathrm{GS}}=10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}, \mathrm{~T}_{\mathrm{J}}=125^{\circ} \mathrm{C}$ |  |  | 0.015 |  |
|  |  | $\mathrm{V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}$ |  | 0.0115 | 0.014 |  |
| Forward Transconductance ${ }^{\text {b }}$ | $\mathrm{gfs}_{\text {f }}$ | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=20 \mathrm{~A}$ | 20 |  |  | S |
| Dynamic ${ }^{\text {a }}$ |  |  |  |  |  |  |
| Input Capacitance | $\mathrm{C}_{\text {iss }}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=25 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ |  | 2200 |  | pF |
| Output Capacitance | $\mathrm{C}_{\text {oss }}$ |  |  | 410 |  |  |
| Reverse Transfer Capacitance | $\mathrm{C}_{\text {rss }}$ |  |  | 180 |  |  |
| Total Gate Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{g}}$ | $\mathrm{V}_{\mathrm{DS}}=15 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=4.5 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=50 \mathrm{~A}$ |  | 11 | 16 | nC |
| Gate-Source Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{gs}}$ |  |  | 7.5 |  |  |
| Gate-Drain Charge ${ }^{\text {c }}$ | $\mathrm{Q}_{\mathrm{gd}}$ |  |  | 5.0 |  |  |
| Gate Resistance | $\mathrm{R}_{\mathrm{g}}$ |  | 0.5 | 1.5 | 2.1 | $\Omega$ |
| Turn-On Delay Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{d}(\mathrm{on})}$ | $\begin{gathered} \mathrm{V}_{\mathrm{DD}}=15 \mathrm{~V}, \mathrm{R}_{\mathrm{L}}=0.3 \Omega \\ \mathrm{I}_{\mathrm{D}} \cong 50 \mathrm{~A}, \mathrm{~V}_{\mathrm{GEN}}=10 \mathrm{~V}, \mathrm{R}_{\mathrm{g}}=2.5 \Omega \end{gathered}$ |  | 9 | 15 | ns |
| Rise Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{r}}$ |  |  | 15 | 25 |  |
| Turn-Off Delay Time ${ }^{\text {c }}$ | $\mathrm{t}_{\mathrm{d} \text { (off) }}$ |  |  | 22 | 35 |  |
| Fall Time ${ }^{\text {c }}$ | $t_{f}$ |  |  | 8 | 12 |  |
| Source-Drain Diode Ratings and Characteristic $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}$ |  |  |  |  |  |  |
| Pulsed Current | $\mathrm{I}_{\text {SM }}$ |  |  |  | 100 | A |
| Diode Forward Voltage ${ }^{\text {b }}$ | $\mathrm{V}_{\text {SD }}$ | $\mathrm{I}_{\mathrm{F}}=50 \mathrm{~A}, \mathrm{~V}_{\mathrm{GS}}=0 \mathrm{~V}$ |  | 1.2 | 1.5 | V |
| Source-Drain Reverse Recovery Time | $\mathrm{t}_{\mathrm{rr}}$ | $\mathrm{I}_{\mathrm{F}}=50 \mathrm{~A}, \mathrm{di} / \mathrm{dt}=100 \mathrm{~A} / \mu \mathrm{s}$ |  | 35 | 70 | ns |

Notes:
a. Guaranteed by design, not subject to production testing.
b. Pulse test; pulse width $\leq 300 \mu \mathrm{~s}$, duty cycle $\leq 2 \%$.
c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS $25^{\circ} \mathrm{C}$, unless otherwise noted


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## SUD50N03-09P

Vishay Siliconix

## THERMAL RATINGS



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71856. Package Information

## TO-252AA Case Outline



|  | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
| DIM. | MIN. | MAX. | MIN. | MAX. |
| A | 2.18 | 2.38 | 0.086 | 0.094 |
| A1 | - | 0.127 | - | 0.005 |
| b | 0.64 | 0.88 | 0.025 | 0.035 |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 |
| C | 0.46 | 0.61 | 0.018 | 0.024 |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 |
| D | 5.97 | 6.22 | 0.235 | 0.245 |
| D1 | 4.10 | - | 0.161 | - |
| E | 6.35 | 6.73 | 0.250 | 0.265 |
| E1 | 4.32 | - | 0.170 | - |
| H | 9.40 | 10.41 | 0.370 | 0.410 |
| e | 2.28 | BSC | 0.090 | BSC |
| e1 | 4.56 BSC | 0.180 | BSC |  |
| L | 1.40 | 1.78 | 0.055 | 0.070 |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 |
| L4 | - | 1.02 | - | 0.040 |
| L5 | 1.01 | 1.52 | 0.040 | 0.060 |
| ECN: T16-0236-Rev. P, 16-May-16 |  |  |  |  |
| DWG: 5347 |  |  |  |  |

Notes

- Dimension L3 is for reference only.


## RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads
Dimensions in Inches/(mm)

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